imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







NPN Power Silicon Transistor

Qualified per MIL-PRF-19500/315

DESCRIPTION

This NPN silicon transistor is rated at 5 amps and is military qualified up to the JANTXV level. This TO-111 isolated package features a 180 degree lead orientation.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered 2N3749
- Low saturation voltage
- Low leakage current
- Fast switching capable 0.5 μs rise time
- High frequency response
- TO-111 case with isolated terminals
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/315
- RoHS compliant versions available (commercial grade only)

APPLICATIONS / BENEFITS

- Class 3B to ESD per MIL-STD-750 Method 1020
- High frequency inverters
- Converters
- Linear amplifiers
- High speed switching regulated power supplies
- RF power supplies

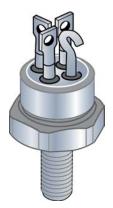
MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit	
Junction and Storage Temperature		T_J and T_{STG}	-65 to +200	°C
Thermal Resistance Junction-to-Case		R _{eJC}	3.33	°C/W
Collector Current		Ι _C	5.0	Α
Collector-Emitter Voltage		V _{CEO}	80	V
Collector-Base Voltage		V _{CBO}	110	V
Emitter-Base Voltage		V _{EBO}	8.0	V
Total Power Dissipation	@ $T_A = +25^{\circ}C^{(1)}$	Ρ _T	2.0	W
	$@ T_{C} = +100^{\circ}C^{(2)}$		30	

<u>Notes</u>: 1. Derate linearly 11.4 mW/°C for $T_A > +25^{\circ}C$.

2. Derate linearly 300 mW/°C for $T_{\rm C}$ > +100°C.

<u>Qualified Levels:</u> JAN, JANTX, and JANTXV



TO-111 Package

MSC – Lawrence

6 Lake Street, Lawrence, MA 01841 1-800-446-1158 (978) 620-2600 Fax: (978) 689-0803

MSC – Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

Website:

www.microsemi.com



RoHS Compliance

e3 = RoHS Compliant (available

on commercial grade only)

Blank = non-RoHS Compliant

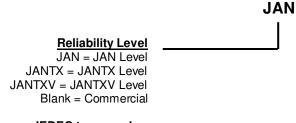
MECHANICAL and PACKAGING

- CASE: Nickel Plated
- TERMINALS: Solder Dip over Nickel Plating. RoHS compliant Matte/Tin available on commercial grade only.
- MARKING: Manufacturer's ID, Date Code, Part Number, BeO
- POLARITY: See Package Outline Drawing on last page
- WEIGHT: Approximately 5.412 grams
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE

2N3749

(e3)



JEDEC type number (see Electrical Characteristics table)

SYMBOLS & DEFINITIONS			
Symbol	Definition		
Ι _Β	Base current: The value of the dc current into the base terminal.		
Ι _C	Collector current: The value of the dc current into the collector terminal.		
Ι _Ε	Emitter current: The value of the dc current into the emitter terminal.		
PT	Total power dissipation: The sum of the forward and reverse power dissipations.		
V _{BE}	Base-emitter voltage: The dc voltage between the base and the emitter.		
V _{CE}	Collector-emitter voltage: The dc voltage between the collector and the emitter.		
V _{CEO}	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.		
V _{CB}	Collector-base voltage: The dc voltage between the collector and the base.		
V _{CBO}	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.		
V _{EB}	Emitter-base voltage: The dc voltage between the emitter and the base		
V _{EBO}	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.		



Characteristic	Symbol	Min.	Max.	Uni
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage		00		V
$I_{\rm C} = 100 \rm{mA}$	V _{(BR)CEO}	80		V
Collector-Emitter Breakdown Voltage $I_{C} = 10 \ \mu A$	V _{(BR)CBO}	110		۷
Emitter-Base Breakdown to Voltage $I_E = 10 \ \mu A$	V _{(BR)EBO}	8.0		V
Collector-Emitter Cutoff Current $V_{CE} = 60 V$	I _{CEO}		20	μΔ
Collector-Base Cutoff Current V _{CB} = 80 V	I _{CBO}		0.2	μA
Collector-Emitter Cutoff Current $V_{CE} = 110 \text{ V}, \text{ V}_{BE} = -0.5$	I _{CEX}		1.0	μA
Emitter-Base Cutoff Current V _{EB} = 6.0 V	I _{EBO}		0.2	μA
N CHARACTERISTICS			1	
Forward-Current Transfer Ratio $I_{C} = 50 \text{ mA}, V_{CE} = 5.0 \text{ V}$ $I_{C} = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$ $I_{C} = 5.0 \text{ A}, V_{CE} = 5.0 \text{ V}$	h _{FE}	40 40 15	120 120	
Base-Emitter Voltage Non-saturated $V_{CE} = 2.0 \text{ V}, I_{C} = 1.0 \text{ A}$	V _{BE}		1.2	v
Collector-Emitter Saturation Voltage $I_C = 1.0 \text{ A}, I_B = 0.1 \text{ A}$ $I_C = 5.0 \text{ A}, I_B = 0.5 \text{ A}$	V _{CE(sat)}		0.25 1.5	V
Base-Emitter Saturation Voltage $I_{C} = 1.0 \text{ A}, I_{B} = 0.1 \text{ A}$	V _{BE(sat)}		1.2	V
YNAMIC CHARACTERISTICS				_
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_{C} = 1.0 \text{ A}, V_{CE} = 10.0 \text{ V}, f = 10 \text{ MHz}$	h _{fe}	3.0	12	
Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_{C} = 50 \text{ mA}, V_{CE} = 5.0 \text{ V}, f = 1 \text{ kHz}$	h _{fe}	40	140	
Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \le f \le 1.0 \text{ MHz}$	C _{obo}		150	pF

0 - 0 -

SWITCHING CHARACTERISTICS

Pulse delay time	t _d	60	ns
Pulse rise time	t _r	300	ns
Pulse storage time	ts	1.7	μS
Pulse fall time	t _f	300	ns



ELECTRICAL CHARACTERISTICS @ $T_c = 25^{\circ}C$ unless otherwise noted. (continued)

SAFE OPERATING AREA (See Figure below and MIL-STD-750, Test Method 3053)

 $\begin{array}{l} \textbf{DC Tests} \\ T_{C} = +100^{0}\text{C}, \ t = 10 \ \text{seconds} \\ \textbf{Test 1} \\ V_{CE} = 80 \ \text{V}, \ \textbf{I}_{C} = 80 \ \text{mA} \\ \textbf{Test 2} \\ V_{CE} = 20 \ \text{V}, \ \textbf{I}_{C} = 1.5 \ \text{A} \end{array}$

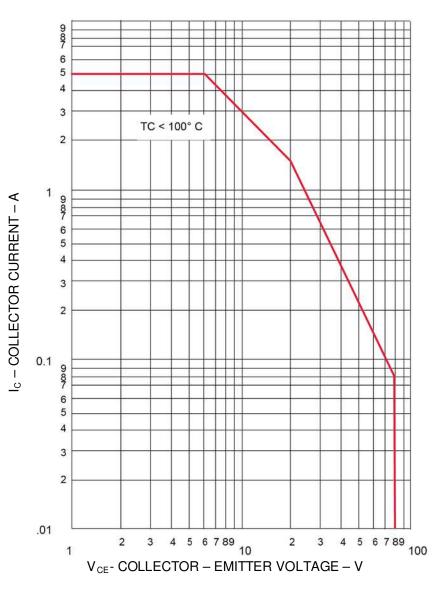


FIGURE 1 Maximum Safe Operating Area



GRAPHS

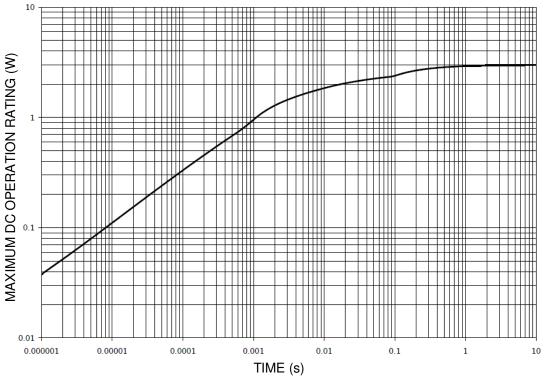
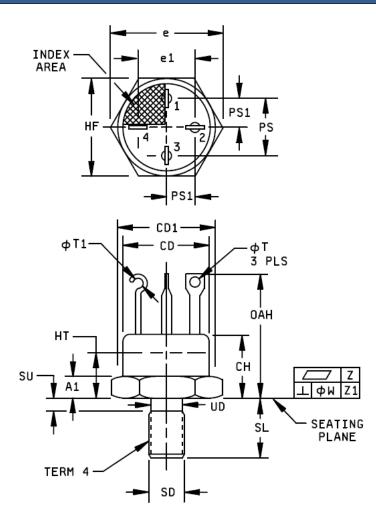


FIGURE 2 Thermal Impedance



PACKAGE DIMENSIONS



NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Terminal 1 emitter; terminal 2 base; terminal 3 collector; terminal 4 case.
- 4. Chamfer or undercut on one, or both, ends of hexagonal portion is optional.
- 5. The outline contour, with the exception of the hexagon, is optional within cylinder defined by CD1 and HT.
- 6. Terminal 4 can be flattened and pierced or hook type. A visual index is required when the flattened and pierced tab terminal contour (identical to the adjacent terminals) option is used.
- 7. Angular orientation of terminals with respect to hexagon is optional.
- 8. A1 dimension does not include sealing flanges.
- 9. SU is the length of incomplete or undercut threads.
- 10. SD is the outer diameter of coated threads. (Reference: Screw thread standards for Federal Standard H28/1, (FED-STD-H28/1)

	Dimension					
Symbol	Inch		Millimeters		Notes	
-,	Min	Max	Min	Max		
СН	0.0320	0.458	8.13	11.63		
HT	-	0.250	-	6.35	5	
CD	0.318	0.380	8.08	9.65		
CD1	0.380	0.437	9.65	11.10	5	
HF	0.423	0.438	10.74	11.13		
E	-	0.505	-	12.83		
E1	0.180	0.215	4.57	5.46	7	
A1	0.090	0.0150	2.29	3.81	4, 8	
OAH	0.570	0.763	14.48	19.38		
SL	0.400	0.0455	10.16	11.56		
SU	-	0.078	-	1.98	9	
φT	0.040	0.065	1.02	1.65		
φT1	0.040	0.070	1.02	1.78	6	
SD	0.190-32UNF-2A		10			
Z	-	0.02	-	0.05		
Z1	-	0.006	-	0.15		